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Kind regards,

Team Nexperia

Schottky barrier single diode 24 July 2012

Product data sheet

1. Product profile

1.1 General description

Planar Schottky barrier diode with an integrated guard ring for stress protection, encapsulated in a SOD523 (SC-79) ultra small Surface-Mounted Device (SMD) plastic package.

1.2 Features and benefits

- Very low forward voltage
- Very low reverse current
- Guard ring protected
- Ultra small SMD package
- AEC-Q101 qualified

1.3 Applications

- Ultra high-speed switching
- Voltage clamping
- Blocking diodes

1.4 Quick reference data

Table 1. Quick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _F	forward current			-	-	200	mA
V _R	reverse voltage			-	-	40	V
V _F	forward voltage	I _F = 10 mA; T _{amb} = 25 °C		-	320	360	mV

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode[1]	1 2	K 🛃 A
2	А	anode		aaa-003679
			SOD523	

[1] The marking bar indicates the cathode.





3. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
1PS79SB30	SOD523	plastic surface-mounted package; 2 leads	SOD523				

4. Marking

Table 4. Marking codes	
Type number	Marking code
1PS79SB30	G1

5. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _R	reverse voltage		-	40	V
l _F	forward current		-	200	mA
I _{FRM}	repetitive peak forward current	t _p ≤ 1 s; δ ≤ 0.5	-	300	mA
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; half sine wave	-	1	A
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	150	°C
T _{stg}	storage temperature		-65	150	°C

6. Thermal characteristics

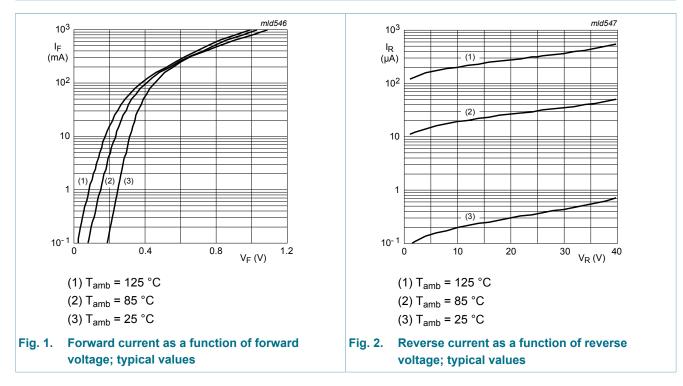
Table 6. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	450	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

Schottky barrier single diode

7. Characteristics

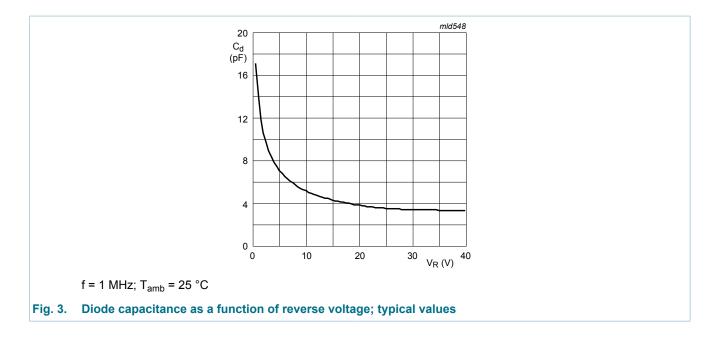
Table 7. Cha	racteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
VF	forward voltage	I _F = 0.1 mA; T _{amb} = 25 °C	-	190	220	mV
		I _F = 1 mA; T _{amb} = 25 °C	-	250	290	mV
		I _F = 10 mA; T _{amb} = 25 °C	-	320	360	mV
		I _F = 100 mA; T _{amb} = 25 °C	-	440	500	mV
		I _F = 200 mA; T _{amb} = 25 °C	-	520	600	mV
I _R	reverse current	V _R = 25 V; T _{amb} = 25 °C; pulsed; t _p = 300 μs; δ = 0.02	-	-	0.5	μA
C _d	diode capacitance	f = 1 MHz; T _{amb} = 25 °C; V _R = 1 V	-	-	20	pF



NXP Semiconductors

1PS79SB30

Schottky barrier single diode

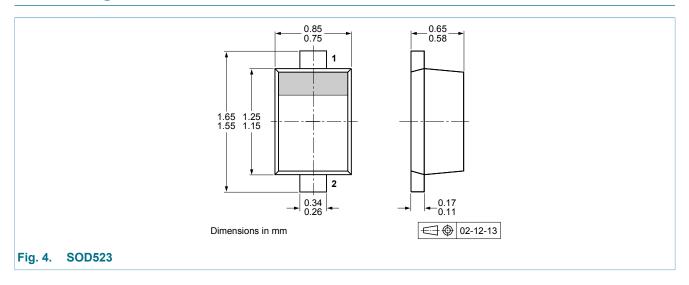


8. Test information

8.1 Quality information

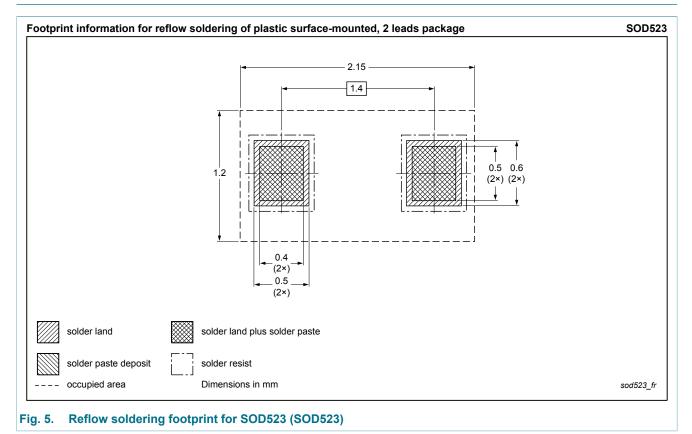
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

9. Package outline



Schottky barrier single diode

10. Soldering



11. Revision history

Table 8. Revisior	n history			
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
1PS79SB30 v.2	20120724	Product data sheet	-	1PS79SB30 v.1
Modifications:	of NXP Semico Legal texts hav Section "Produ Section "Markir Package outline	nductors. e been adapted to the new ct profile" updated ng" added e drawing replaced by minir formation" added	company name where	
1PS79SB30 v.1	20010220	Product data sheet	-	-

Schottky barrier single diode

12. Legal information

12.1 Data sheet status

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Document status [<u>1][2]</u>	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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